



MOSFET

OptiMOS[™] 5 Power-Transistor, 30 V

Features

- Optimized for high performance SMPS, e.g. sync.rec.
 Very low on-resistance R_{DS(on)} @ V_{GS}=4.5 V
 100% avalanche tested

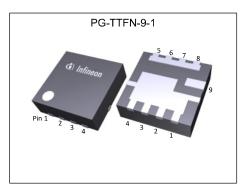
- Superior thermal resistance
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

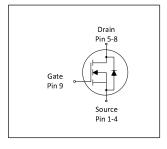
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	30	V
R _{DS(on),max}	0.85	mΩ
ID	253	A
Qoss	31	nC
Q _G (0V4.5V)	30	nC









Type / Ordering Code	Package	Marking	Related Links
IQE008N03LM5CG	PG-TTFN-9-1	00803C5	-

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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

Deveryor	Cump hal		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -		253 160 27	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =4.5V, T_{A} =25°C, R_{thJA} =60°C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1012	А	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	EAS	-	-	50	mJ	I _D =20 A, R _{GS} =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	-	89 2.1	w	$T_{\rm C}=25 \ ^{\circ}{\rm C}$ $T_{\rm A}=25 \ ^{\circ}{\rm C}, \ R_{\rm thJA}=60 \ ^{\circ}{\rm C/W}^{2)}$
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Deveneter	Symphol	Values			11	Note / Tool Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1.4	°C/W	-	
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	60	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

 ³⁾ See Diagram 3 for more detailed information
 ⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Davamatan	Currente e l	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	1.6	2.0	V	V _{DS} =V _{GS} , <i>I</i> _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =24 V, V _{GS} =0 V, T _j =25 °C V _{DS} =24 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.65 0.80	0.85 1.4	mΩ	V _{GS} =10 V, <i>I</i> _D =20 A V _{GS} =4.5 V, <i>I</i> _D =20 A
Gate resistance	R _G	-	0.6	-	Ω	-
Transconductance	$g_{ m fs}$	-	190	-	S	<i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =20 A

Table 5Dynamic characteristics

Parameter	Currente e l		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	4400	5700	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1100	1400	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	110	190	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	18.6	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	tr	-	37.7	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	t _{d(off)}	-	32.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	tf	-	9.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	O	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	10	-	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	6	-	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q _{gd}	-	6	9	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	10	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	30	37	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.3	-	V	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total	Qg	-	64	-	nC	V_{DD} =15 V, I_{D} =20 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	31	41	nC	V _{DS} =15 V, V _{GS} =0 V

¹⁾ Defined by design. Not subject to production test.
²⁾ See "Gate charge waveforms" for parameter definition

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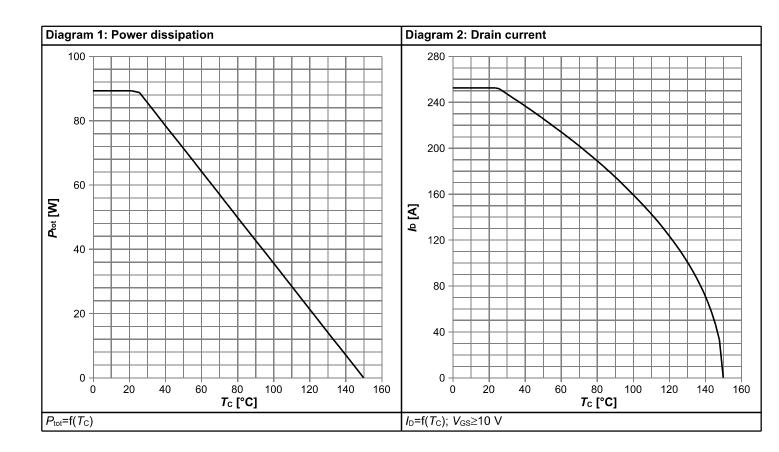
Table 7Reverse diode

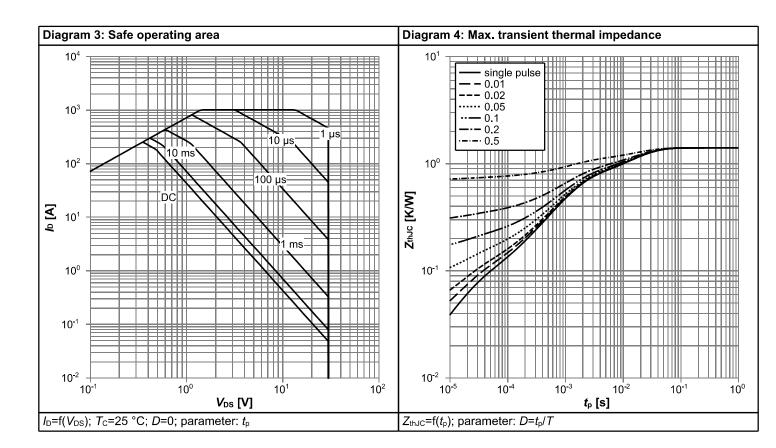
Devemeter	Symbol	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	81	A	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1012	A	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.73	1.0	V	V _{GS} =0 V, <i>I</i> _F =20 A, <i>T</i> _j =25 °C	
Reverse recovery charge ¹⁾	Q _{rr}	-	27	54	nC	<i>V</i> _R =15 V, <i>I</i> _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	

¹⁾ Defined by design. Not subject to production test.

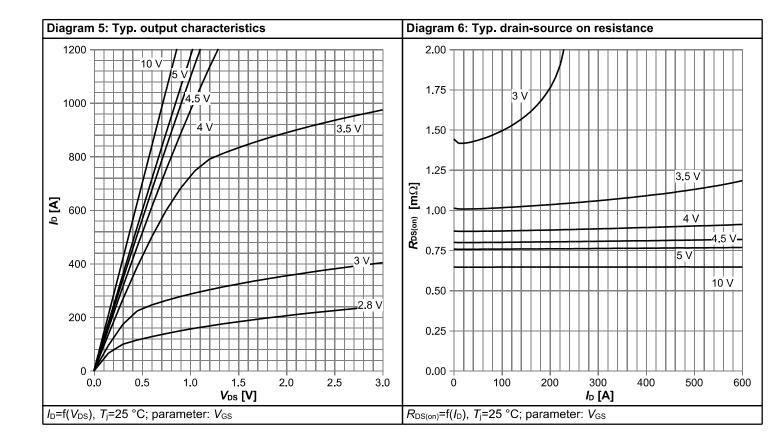


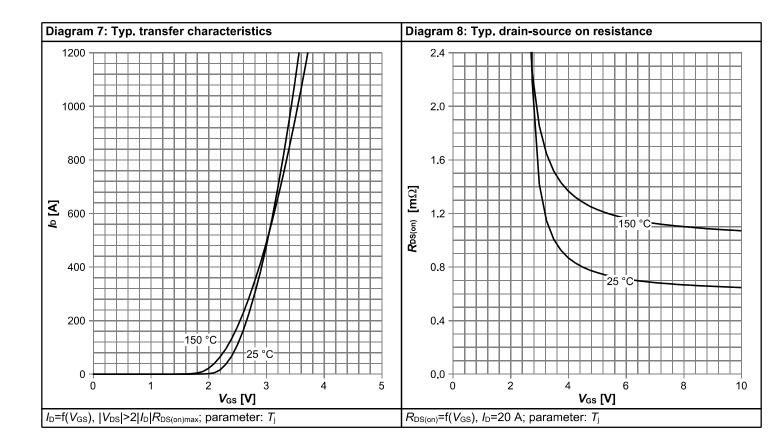
4 Electrical characteristics diagrams



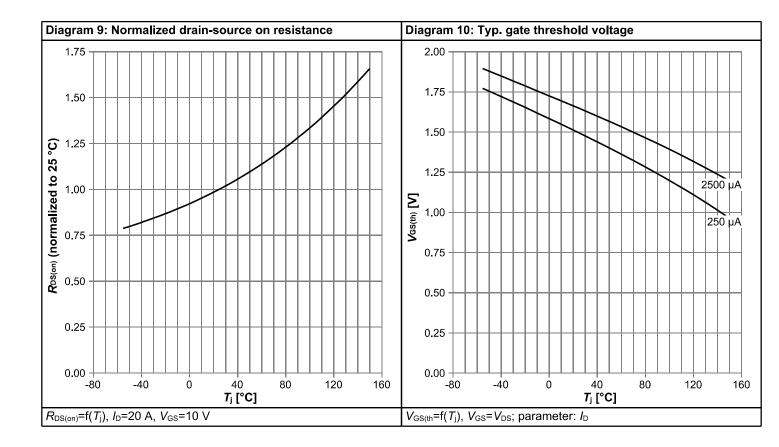


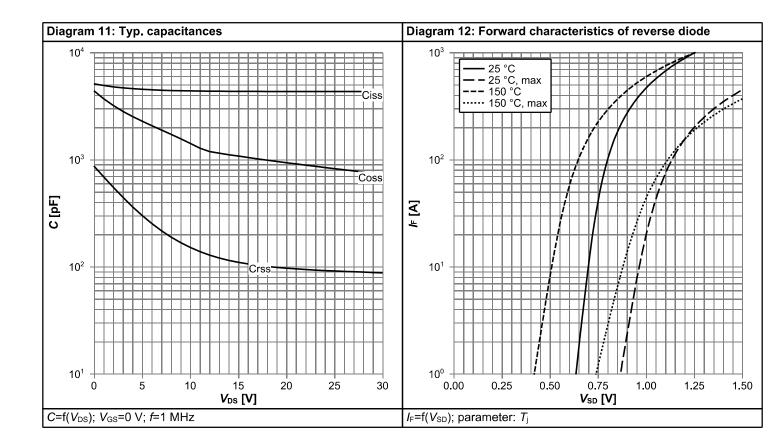




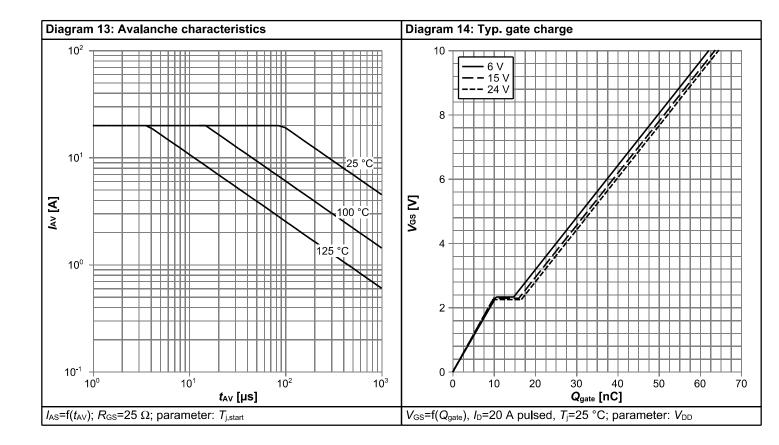


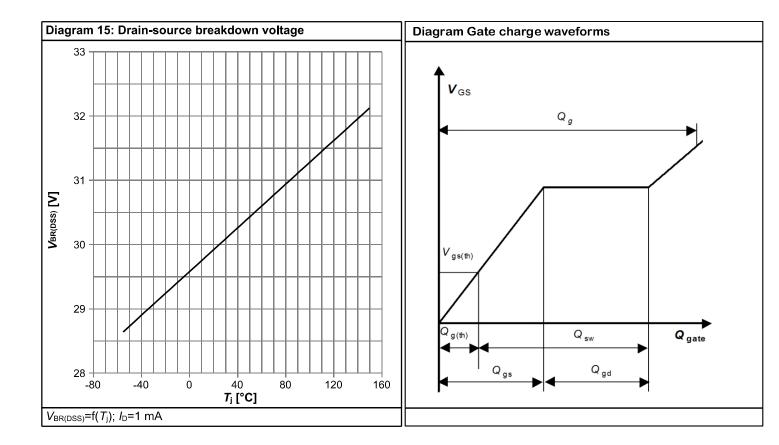






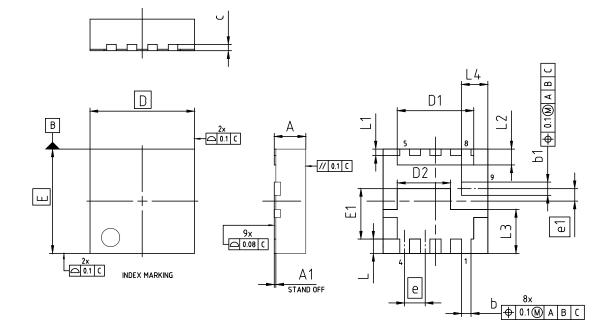








5 Package Outlines



DIMENSION	MILLIM	ETERS				
DIMENSION	MIN.	MAX.				
A	-	1.10				
A1	-	0.05				
b	0.20	0.40				
b1	0.32	0.52				
С	0.:	20				
D	3.30					
D1	2.31	2.51				
D2	1.58	1.78				
E	3.30					
E1	1.50	1.70				
e	0.65					
e1	0.395					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.285	1.485				
L4	0.73	0.93				

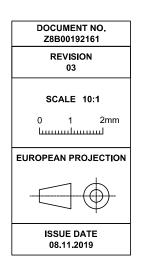


Figure 1 Outline PG-TTFN-9-1, dimensions in mm



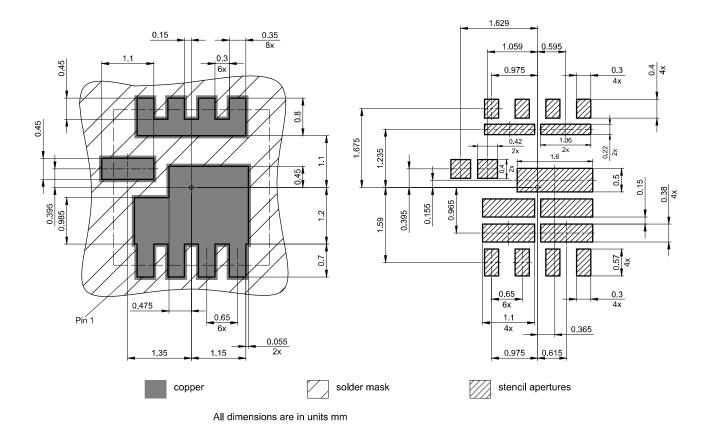


Figure 2 Outline Boardpad (PG-TTFN-9-1), dimensions in mm



Revision History

IQE008N03LM5CG

Revision: 2021-04-28, Rev. 2.0

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2021-04-28	Release of final version				

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